

FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
MIC-24 Cont.APPLN. NO.
10/644,278APPLICANT
Kie Y. Ahn et al.CONF. NO.
5174FILING DATE
August 19, 2003GROUP ART UNIT
1765INFORMATION DISCLOSURE
STATEMENT BY APPLICANT

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
TTN	6,025,261	2/2000	Farrar et al.	438	619	
	6,083,802	7/2000	Wen et al.	438	381	
	6,107,893	8/2000	Forbes	331	132	
	6,191,468	2/2001	Forbes et al.	257	531	
	6,201,287	3/2001	Forbes	257	528	
	6,239,684	5/2001	Farrar et al.	336	200	
	6,240,622	6/2001	Ahn et al.	29	604	
	6,245,615	6/2001	Noble et al.	438	270	
	6,249,191	6/2001	Forbes	331	117FE	
	6,251,470	6/2001	Forbes et al.	427	97	
	6,277,728	8/2001	Ahn et al.	438	619	
	6,287,932	9/2001	Forbes et al.	438	381	
	6,414,550	7/2002	Forbes	330	264	
	6,420,954	7/2002	Ahn et al.	336	232	
	6,492,708	12/2002	Acosta et al.	257	531	
9	6,535,101	3/2003	Ahn et al.	336	232	
TTN	2003/0071325	4/2003	Xu et al.	257	531	

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO

EXAMINER

NGUYEN

DATE CONSIDERED

6/11/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
MIC-24 Cont.APPLN. NO.
10/644,278APPLICANT
Kie Y. Ahn et al.CONF. NO.
5174FILING DATE
August 19, 2003GROUP ART UNIT
1765INFORMATION DISCLOSURE
STATEMENT BY APPLICANT

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER INITIAL	
TTN	Bassous, E., "Fabrication of Novel Three-Dimensional Microstructures by the Anisotropic Etching of (100) and (110) Silicon," <u>IEEE Transactions on Electron Devices</u> , vol. ED-25, no. 10, pp. 1178-85 (October 1978)
	Brodie, I., et al., <u>The Physics of Microfabrication</u> , pp. 1-78 (Plenum Press, New York 1982)
	Burghartz, J., et al., "Integrated RF and Microwave Components in BiCMOS Technology," <u>IEEE Transactions on Electron Devices</u> , vol. 43, no. 9, pp. 1559-70 (September 1996)
	Burghartz, J., et al., "Multilevel-Spiral Inductors Using VLSI Interconnect Technology," <u>IEEE Electron Device Letters</u> , vol. 17, no. 9, pp. 428-30 (September 1996)
	Chang, J.Y.-C., et al., "Large Suspended Inductors on Silicon and Their Use in a 2- μ m CMOS RF Amplifier," <u>IEEE Electron Device Letters</u> , vol. 14, no. 5, pp. 246-48 (May 1993)
	Frye, R.C., et al., "Inductive Crosstalk Between Integrated Passive Components in RF-Wireless Modules," <u>IEEE Proceedings of the 1998 International Conference on Multichip Modules and High Density Packaging</u> , pp. 496-500 (1998)
TTN	Pieters, P., et al., "Spiral Inductors Integrated in MCM-D using the Design Space Concept," <u>IEEE Proceedings of the 1998 International Conference on Multichip Modules and High Density Packaging</u> , pp. 478-83 (1998)

EXAMINER

NGUYEN

DATE CONSIDERED

6/11/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.